

TPS54620EVM-374 6-A, SWIFT™ Regulator Evaluation Module

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1 Introduction

This user's guide contains background information for the TPS54620 as well as support documentation for the TPS54620EVM-374 evaluation module (HPA374). Also included are the performance specifications, the schematic, and the bill of materials for the TPS54620EVM-374.

1.1 Background

The TPS54620 dc/dc converter is designed to provide up to a 6 A output. The TPS54620 implements a split input power rails with separate input voltage inputs for the power stage and control circuitry. The power stage input (PVIN) is rated for 1.6 V to 17 V while the control input (VIN) is rated for 4.5 to 17 V. The TPS54620EVM-374 provides both inputs but is designed and tested using the PVIN connected to VIN. Rated input voltage and output current range for the evaluation module are given in [Table 1](#). This evaluation module is designed to demonstrate the small printed-circuit-board areas that may be achieved when designing with the TPS54620 regulator. The switching frequency is externally set at a nominal 480 kHz. The high-side and low-side MOSFETs are incorporated inside the TPS54620 package along with the gate drive circuitry. The low drain-to-source on resistance of the MOSFET allows the TPS54620 to achieve high efficiencies and helps keep the junction temperature low at high output currents. The compensation components are external to the integrated circuit (IC), and an external divider allows for an adjustable output voltage. Additionally, the TPS54620 provides adjustable slow start, tracking and undervoltage lockout inputs. The absolute maximum input voltage is 20 V for the TPS54620EVM-374.

Table 1. Input Voltage and Output Current Summary

EVM	INPUT VOLTAGE RANGE	OUTPUT CURRENT RANGE
TPS54620EVM-374	VIN = 8 V to 17 V (VIN start voltage = 6.521 V)	0 A to 6 A

1.2 Performance Specification Summary

A summary of the TPS54620EVM-374 performance specifications is provided in [Table 2](#). Specifications are given for an input voltage of VIN = 12 V and an output voltage of 3.3 V, unless otherwise specified. The TPS54620EVM-374 is designed and tested for VIN = 8 V to 17 V with the VIN and PVIN pins connect together with the J3 jumper. The ambient temperature is 25°C for all measurements, unless otherwise noted.

Table 2. TPS54620EVM-374 Performance Specification Summary

SPECIFICATION	TEST CONDITIONS	MIN	TYP	MAX	UNIT
VIN voltage range (PVIN = VIN)		8	12	17	V
VIN start voltage			6.521		V
VIN stop voltage			6.065		V
Output voltage set point			3.3		V
Output current range	VIN = 8 V to 17 V	0		6	A
Line regulation	IO = 3 A, VIN = 8 V to 17 V		±0.02%		
Load regulation	VIN = 12 V, IO = 0 A to 6 A		±0.012%		
Load transient response	IO = 1.5 A to 4.5 A	Voltage change		–50	mV
		Recovery time		250	µs
	IO = 4.5 A to 1.5 A	Voltage change		60	mV
		Recovery time		250	µs
Loop bandwidth	VIN = 12 V, IO = 6 A		45		kHz
Phase margin	VIN = 12 V, IO = 6 A		46		°
Input ripple voltage	IO = 6 A		520		mVPP
Output ripple voltage	IO = 6 A		18		mVPP
Output rise time			4		ms

Table 2. TPS54620EVM-374 Performance Specification Summary (continued)

SPECIFICATION	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Operating frequency			480		kHz
Maximum efficiency	TPS54620EVM-374, $V_{IN} = 8\text{ V}$, $I_O = 2\text{ A}$		95%		

1.3 Modifications

These evaluation modules are designed to provide access to the features of the TPS54620. Some modifications can be made to this module.

1.3.1 Output Voltage Set Point

The output voltage is set by the resistor divider network of R8 and R9. R9 is fixed at 10 kΩ. To change the output voltage of the EVM, it is necessary to change the value of resistor R8. Changing the value of R8 can change the output voltage above 0.8 V. The value of R8 for a specific output voltage can be calculated using [Equation 1](#).

$$R8 = \frac{10\text{ k}\Omega (V_{OUT} - 0.8\text{ V})}{0.8\text{ V}} \quad (1)$$

[Table 3](#) lists the R8 values for some common output voltages. Note that V_{IN} must be in a range so that the minimum on-time is greater than 120 ns, and the maximum duty cycle is less than 95%. The values given in [Table 3](#) are standard values, not the exact value calculated using [Equation 1](#).

Table 3. Output Voltages Available

Output Voltage (V)	R ₈ Value (kΩ)
1.8	12.4
2.5	21.5
3.3	31.6
5	52.3

1.3.2 Slow Start Time

The slow start time can be adjusted by changing the value of C7. Use [Equation 2](#) to calculate the required value of C7 for a desired slow start time

$$C7(\text{nF}) = \frac{T_{ss}(\text{ms}) \times I_{ss}(\mu\text{A})}{V_{ref}(\text{V})} \quad (2)$$

The EVM is set for a slow start time of 4 msec using C7 = 0.01 μF.

1.3.3 Track In

The TPS54620 can track an external voltage during start up. The J5 connector is provided to allow connection to that external voltage. Ratio-metric or simultaneous tracking can be implemented using resistor divider R5 and R6. See the TPS54620 data sheet ([SLVS949](#)) for details.

1.3.4 Adjustable UVLO

The under voltage lock out (UVLO) can be adjusted externally using R1 and R2. The EVM is set for a start voltage of 6.521 V and a stop voltage of 6.065 V using R1 = 35.7 kΩ and R2 = 8.06 kΩ. Use [Equation 3](#) and [Equation 4](#) to calculate required resistor values for different start and stop voltages.

$$R1 = \frac{V_{START} \left(\frac{V_{ENFALLING}}{V_{ENRISING}} \right) - V_{STOP}}{I_p \left(1 - \frac{V_{ENFALLING}}{V_{ENRISING}} \right) + I_h} \quad (3)$$

$$R2 = \frac{R1 \times V_{ENFALLING}}{V_{STOP} - V_{ENFALLING} + R1(I_p + I_h)} \quad (4)$$

1.3.5 Input Voltage Rails

The EVM is designed to accommodate different input voltage levels for the power stage and control logic. During normal operation, the PVIN and VIN inputs are connected together using a jumper across J3. The single input voltage is supplied at J1. If desired, these two input voltage rails may be separated by removing the jumper across J3. Two input voltages must then be provided at both J1 and J2,

2 Test Setup and Results

This section describes how to properly connect, set up, and use the TPS54620EVM-374 evaluation module. The section also includes test results typical for the evaluation module and covers efficiency, output voltage regulation, load transients, loop response, output ripple, input ripple, and start-up.

2.1 Input / Output Connections

The TPS54620EVM-374 is provided with input/output connectors and test points as shown in [Table 4](#). A power supply capable of supplying 4 A must be connected to J1 through a pair of 20 AWG wires. The jumper across J3 must be in place. See [Section 1.3.5](#) for split input voltage rail operation. The load must be connected to J7 through a pair of 20 AWG wires. The maximum load current capability must be 6 A. Wire lengths must be minimized to reduce losses in the wires. Test-point TP1 provides a place to monitor the V_{IN} input voltages with TP2 providing a convenient ground reference. TP8 is used to monitor the output voltage with TP9 as the ground reference.

Table 4. EVM Connectors and Test Points

Reference Designator	Function
J1	PVIN input voltage connector. (see Table 1 for V_{IN} range).
J2	VIN input voltage connector. Not normally used.
J3	PVIN to VIN jumper. Normally closed to tie VIN to PVIN for common rail voltage operation.
J24	2-pin header for enable. Connect EN to ground to disable, open to enable.
J5	2-pin header for tracking voltage input and ground.
J6	2-pin header for tracking output and ground.
J7	V_{OUT} , 3.3 V at 6 A maximum.
TP1	PVIN test point at PVIN connector.
TP2	GND test point at PVIN connector.
TP3	VIN test point at VIN connector.
TP4	GND test point at VIN connector.
TP5	PH test point .
TP6	Slow start / track in test point.
TP7	Test point between voltage divider network and output. Used for loop response measurements.
TP8	Output voltage test point at VOUT connector
TP9	GND test point at VOUT connector
TP10	PWRGD test point.

2.2 Efficiency

The efficiency of this EVM peaks at a load current of about 2 A and then decreases as the load current increases towards full load. Figure 1 shows the efficiency for the TPS54620EVM-374 at an ambient temperature of 25°C.

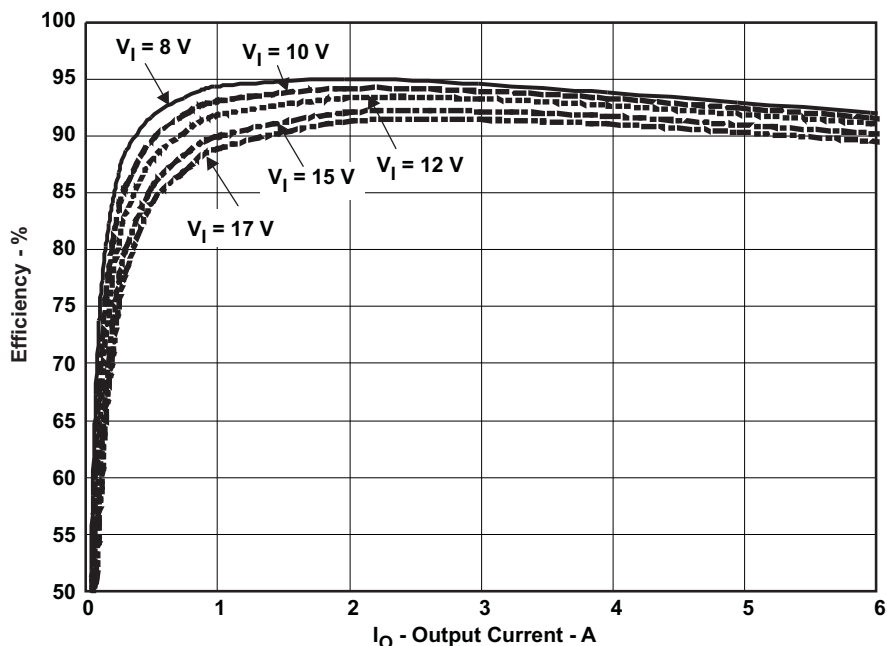


Figure 1. TPS54620EVM-374 Efficiency

Figure 2 shows the efficiency for the TPS54620EVM-374 at lower output currents below 0.10 A at an ambient temperature of 25°C.

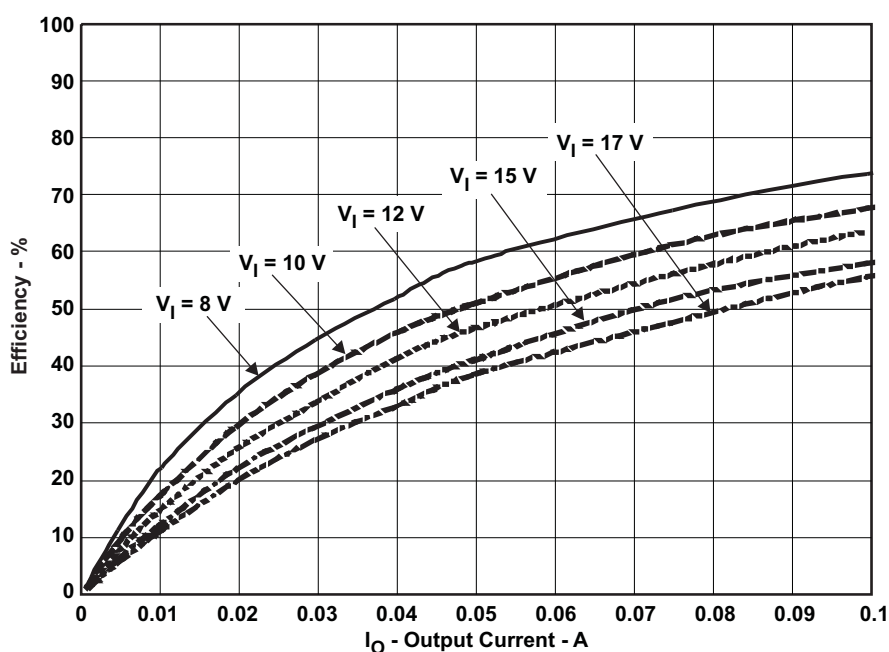


Figure 2. TPS54620EVM-374 Low Current Efficiency

The efficiency may be lower at higher ambient temperatures, due to temperature variation in the drain-to-source resistance of the internal MOSFET.

2.3 Output Voltage Load Regulation

Figure 3 shows the load regulation for the TPS54620EVM-374.

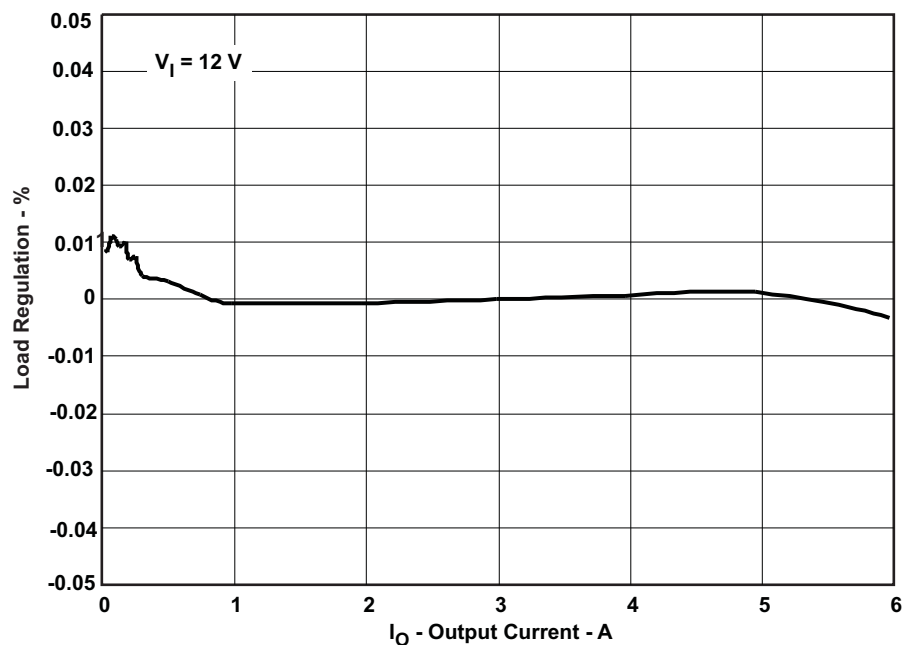


Figure 3. TPS54620EVM-374 Load Regulation

Measurements are given for an ambient temperature of 25°C.

2.4 Output Voltage Line Regulation

Figure 4 shows the line regulation for the TPS54620EVM-374.

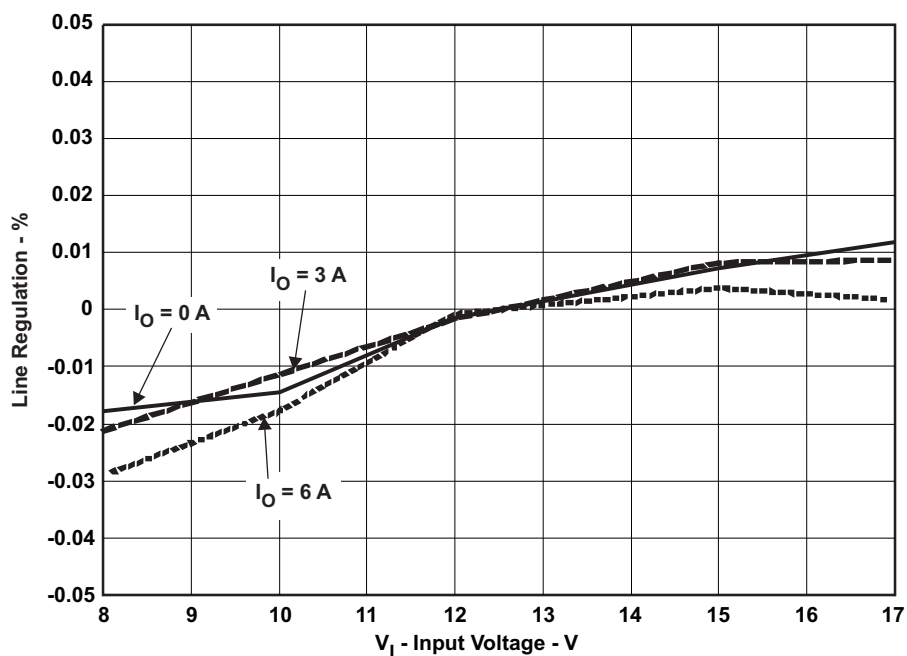


Figure 4. TPS54620EVM-374 Line Regulation

2.5 Load Transients

Figure 5 shows the TPS54620EVM-374 response to load transients. The current step is from 25% to 75% of maximum rated load at 12 V input. Total peak-to-peak voltage variation is as shown, including ripple and noise on the output.

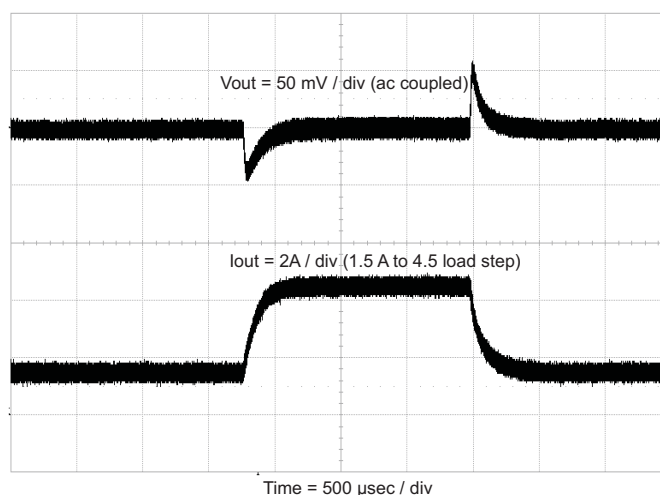


Figure 5. TPS54620EVM-374 Transient Response

2.6 Loop Characteristics

Figure 6 shows the TPS54620EVM-374 loop-response characteristics. Gain and phase plots are shown for V_{IN} voltage of 12 V. Load current for the measurement is 6 A.

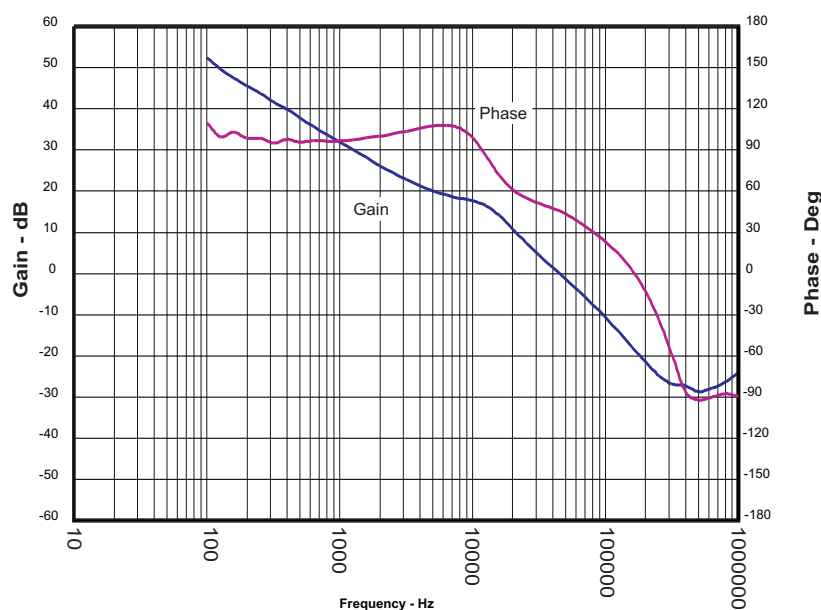


Figure 6. TPS54620EVM-374 Loop Response

2.7 Output Voltage Ripple

Figure 7 shows the TPS54620EVM-374 output voltage ripple. The output current is the rated full load of 6 A and $V_{IN} = 12$ V. The ripple voltage is measured directly across the output capacitors.

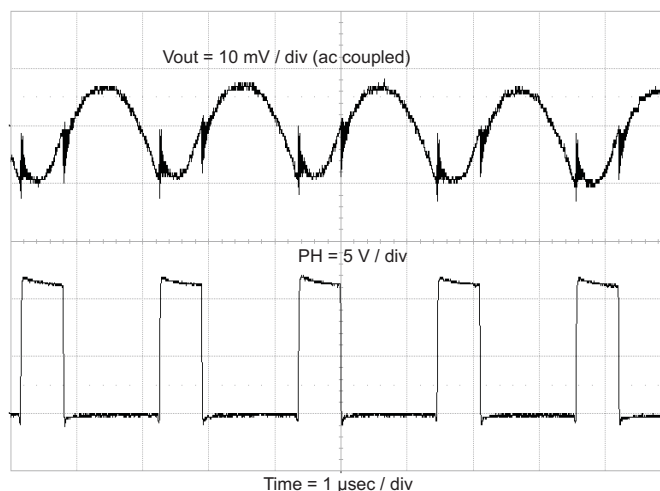


Figure 7. TPS54620EVM-374 Output Ripple

2.8 Input Voltage Ripple

Figure 8 shows the TPS54620EVM-374 input voltage. The output current is the rated full load of 4 A and $V_{IN} = 12$ V. The ripple voltage is measured directly across the input capacitors.

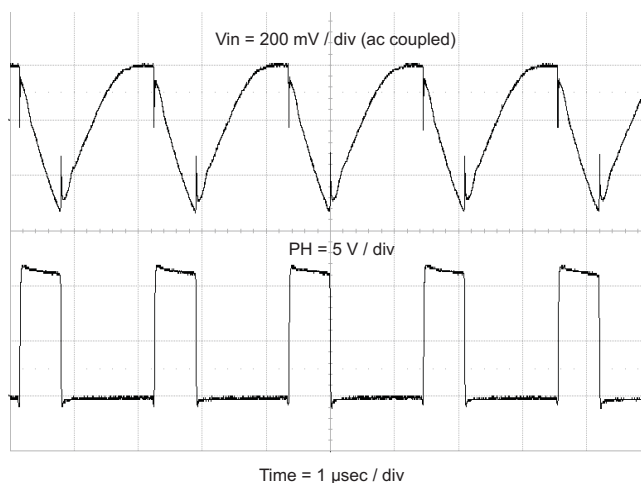


Figure 8. TPS54620EVM-374 Input Ripple

2.9 Powering Up

Figure 9 and Figure 10 show the start-up waveforms for the TPS54620EVM-374. In Figure 9, the output voltage ramps up as soon as the input voltage reaches the UVLO threshold as set by the R1 and R2 resistor divider network. In Figure 10, the input voltage is initially applied and the output is inhibited by using a jumper at J2 to tie EN to GND. When the jumper is removed, EN is released. When the EN voltage reaches the enable-threshold voltage, the start-up sequence begins and the output voltage ramps up to the externally set value of 3.3 V. The input voltage for these plots is 12 V and the load is 1 Ω .

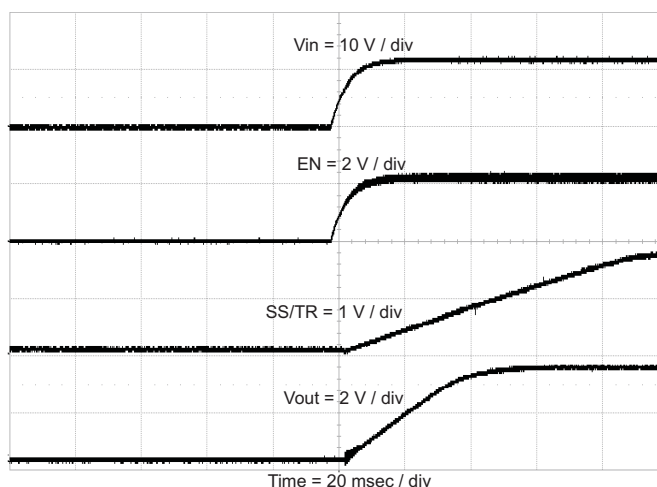


Figure 9. TPS54620EVM-374 Start-Up Relative to V_{IN}

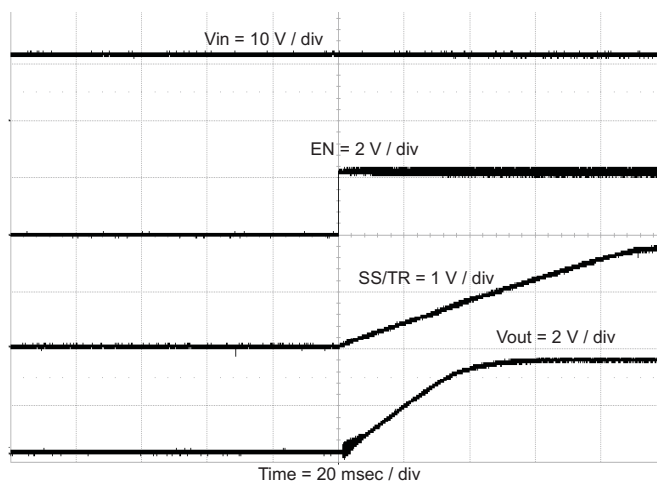


Figure 10. TPS54620EVM-374 Start-up Relative to Enable

2.10 Thermal Characteristics

This section shows a thermal image of the TPS54620EVM-374 running at 12 V input and 6 A load. there is no air flow and the ambient temperature is 25°C. The peak temperature of the IC (70°C) is well below the maximum recommended operating condition listed in the data sheet of 150°C.

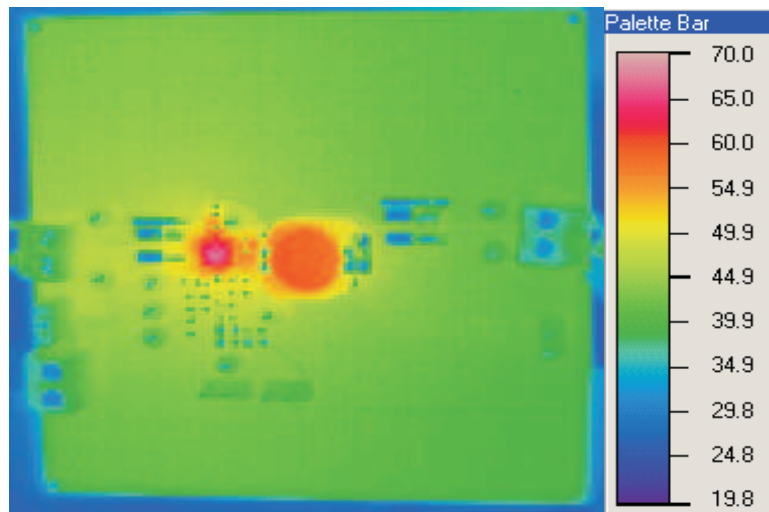


Figure 11. TPS54620EVM-374 Thermal Image

3 Board Layout

This section provides a description of the TPS54620EVM-374, board layout, and layer illustrations.

3.1 Layout

The board layout for the TPS54620EVM-374 is shown in [Figure 12](#) through [Figure 16](#). The topside layer of the EVM is laid out in a manner typical of a user application. The top, bottom and internal layers are 2-oz. copper.

The top layer contains the main power traces for PVIN, VIN, V_{OUT}, and VPHASE. Also on the top layer are connections for the remaining pins of the TPS54620 and a large area filled with ground. The bottom and internal ground layers contains ground planes only. The top side ground traces are connected to the bottom and internal ground planes with multiple vias placed around the board including two vias directly under the TPS54620 device to provide a thermal path from the top-side ground plane to the bottom-side ground plane.

The input decoupling capacitors (C2, and C3) and bootstrap capacitor (C5) are all located as close to the IC as possible. In addition, the voltage set-point resistor divider components are also kept close to the IC. The voltage divider network ties to the output voltage at the point of regulation, the copper V_{OUT} trace at the J7 output connector. For the TPS54620, an additional input bulk capacitor may be required, depending on the EVM connection to the input supply. Critical analog circuits such as the voltage setpoint divider, frequency set resistor, slow start capacitor and compensation components are terminated to ground using a wide ground trace separate from the power ground pour.

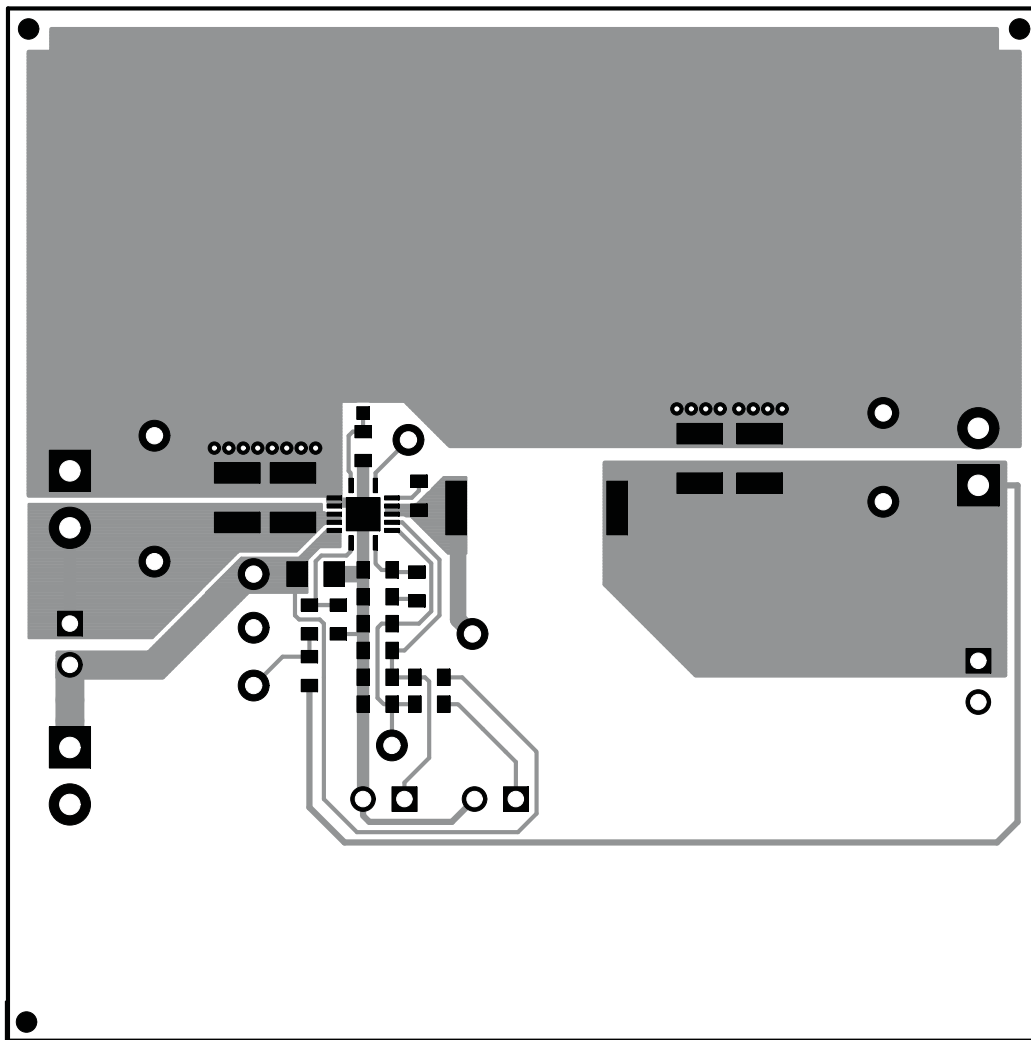


Figure 12. TPS54620EVM-374 Top-Side Layout

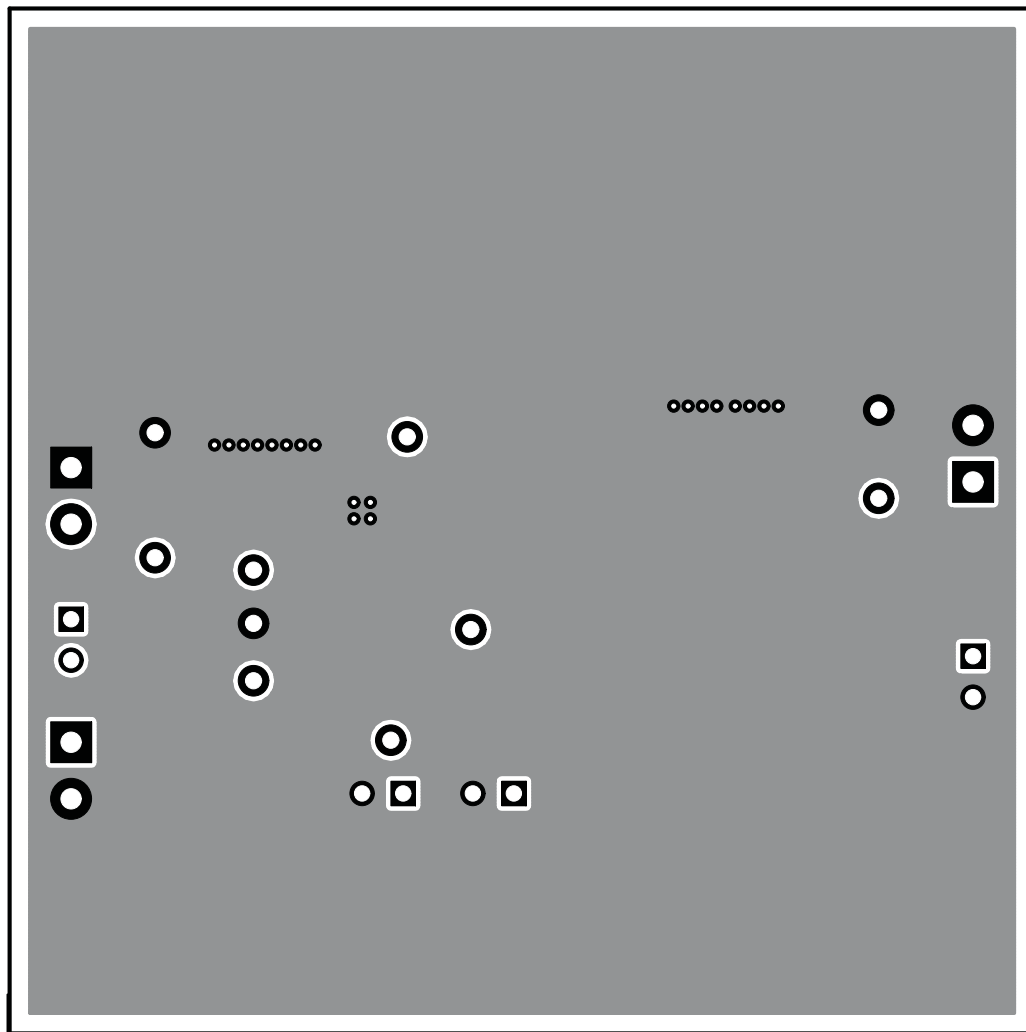


Figure 13. TPS54620EVM-374 Layout 2

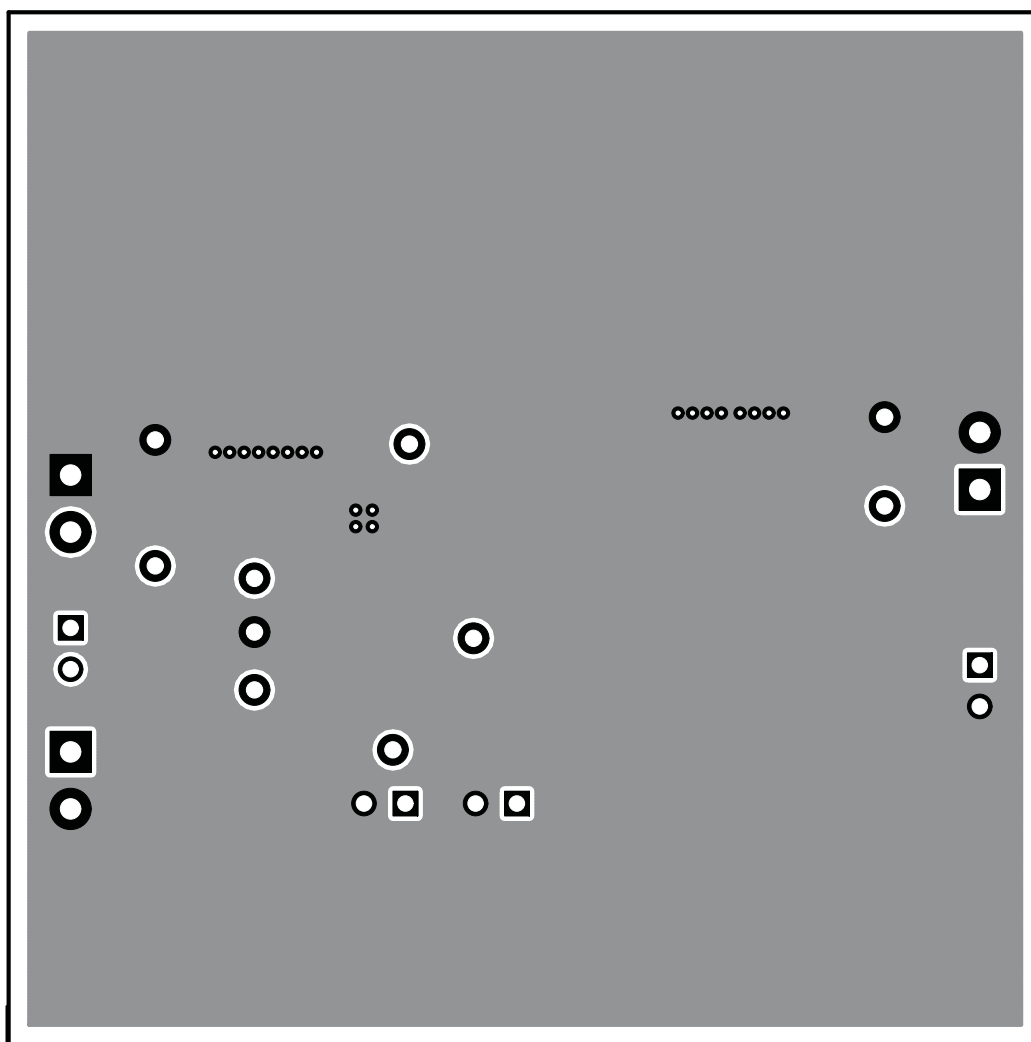


Figure 14. TPS54620EVM-374 Layout 3

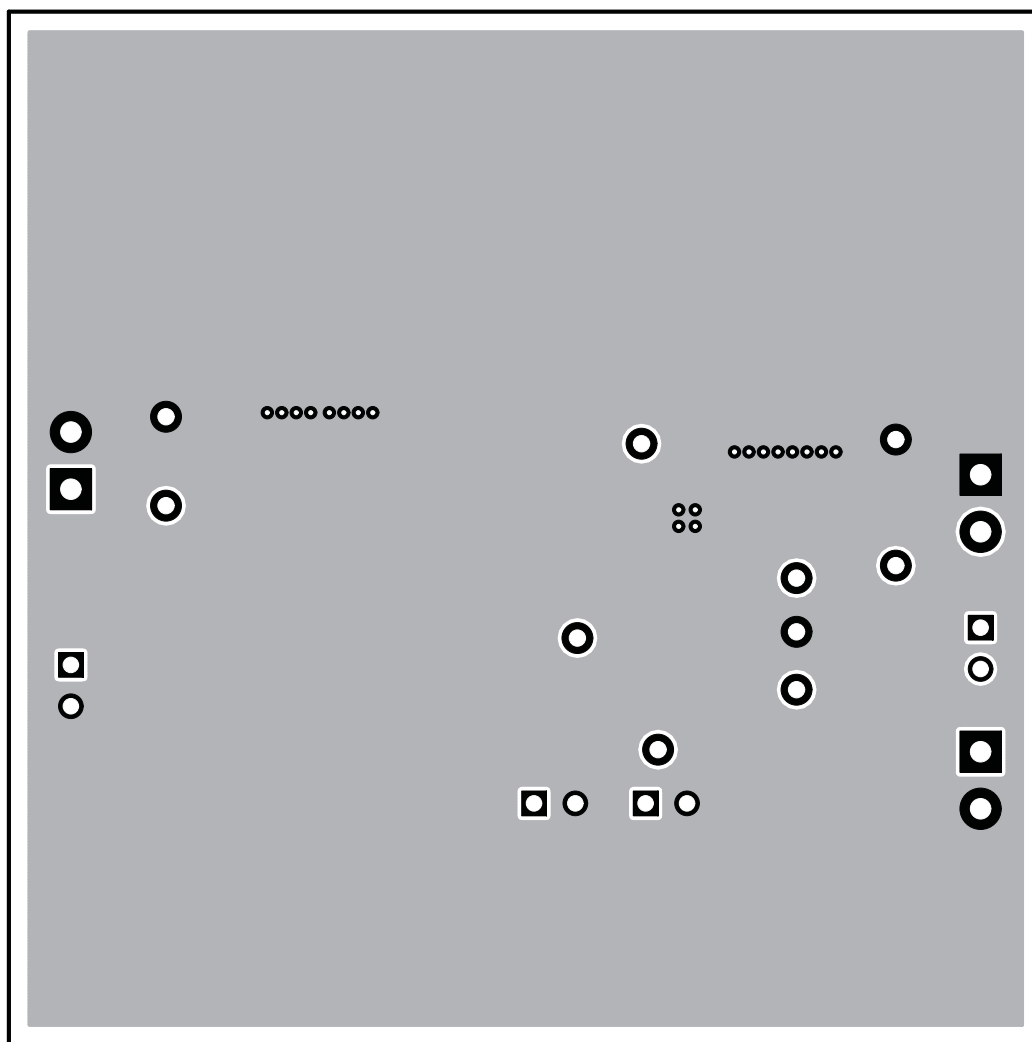


Figure 15. TPS54620EVM-374 Bottom-Side layout

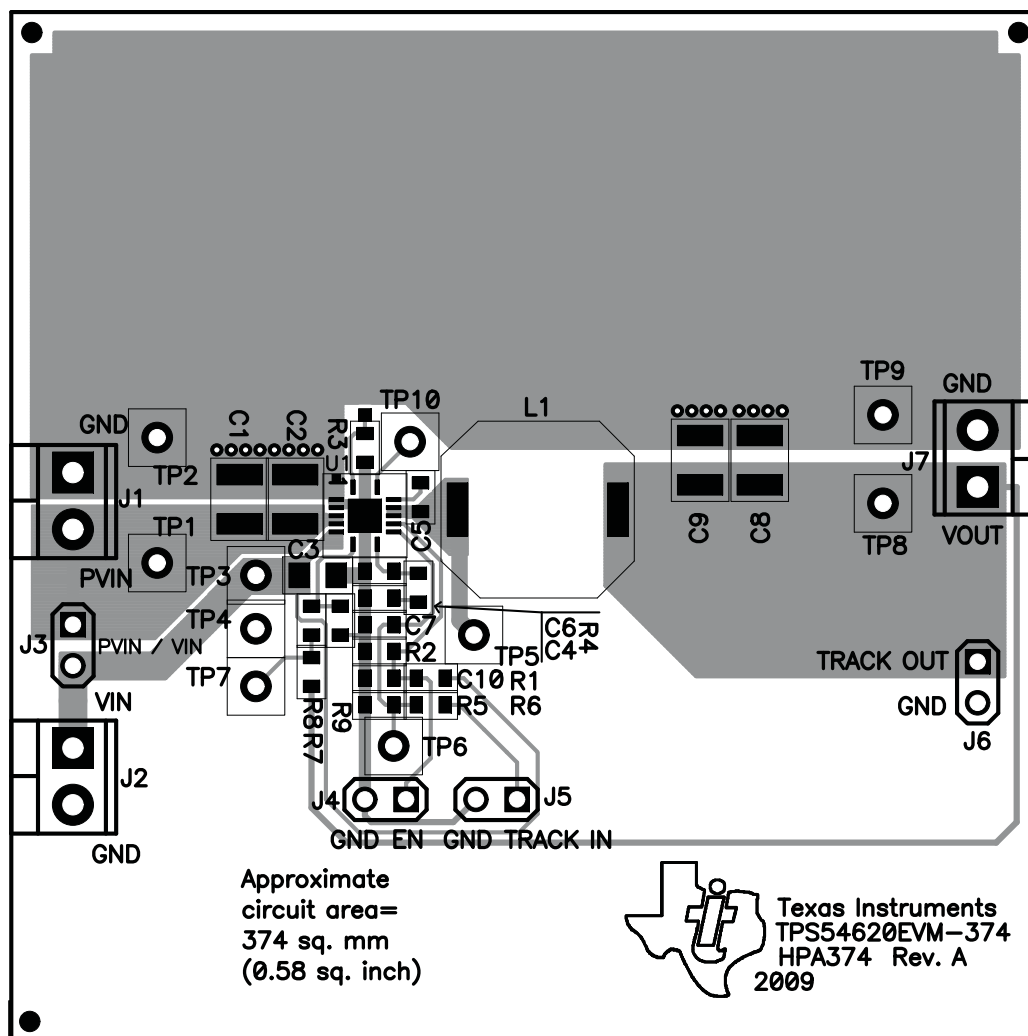


Figure 16. TPS54620EVM-374 Top-Side Assembly

3.2 Estimated Circuit Area

The estimated printed circuit board area for the components used in this design is 0.58 in² (374 mm²). This area does not include test point or connectors.

4 Schematic and Bill of Materials

This section presents the TPS54620EVM-374 schematic and bill of materials.

4.2 Bill of Materials

Table 5 presents the bill of materials for the TPS54620EVM-374.

Table 5. TPS54620EVM-374 Bill of Materials

Count	RefDes	Value	Description	Size	Part Number	MFR
0	C1	Open	Capacitor, Ceramic, 25V, X5R, 20%	1210	Std	Std
1	C2	10uF	Capacitor, Ceramic, 25V, X5R, 20%	1210	Std	Std
1	C3	4.7uF	Capacitor, Ceramic, 25V, X5R, 10%	0805	Std	Std
1	C4	8200pF	Capacitor, Ceramic, 50V, X7R, 10%	0603	Std	Std
1	C5	0.1uF	Capacitor, Ceramic, 50V, X7R, 10%	0603	Std	Std
0	C6, C10	Open	Capacitor, Ceramic, vvV, [temp], [tol]	0603	Std	Std
1	C7	0.01uF	Capacitor, Ceramic, 25V, X7R, 10%	0603	Std	Std
1	C8	47uF	Capacitor, Ceramic, 6.3V, X5R, 10%	1210	Std	Std
0	C9	Open	Capacitor, Ceramic, 6.3V, X5R, 10%	1210	Std	Std
3	J1, J2, J7	ED555/2DS	Terminal Block, 2-pin, 6-A, 3.5mm	0.27 x 0.25 inch	ED555/2DS	OST
4	J3, J4, J5, J6	PEC02SAAN	Header, Male 2-pin, 100mil spacing	0.100 inch x 2	PEC02SAAN	Sullins
1	L1	3.3uH	Inductor, SMT, 7.2A, 10.4milliohm	0.402 sq inch	MSS1048-332NL_	Coilcraft
1	R1	35.7K	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R2	8.06K	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R3	100K	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R4	1.69K	Resistor, Chip, 1/16W, 1%	0603	Std	Std
0	R5, R6	Open	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R7	0	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R8	31.6K	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R9	10.0K	Resistor, Chip, 1/16W, 1%	0603	Std	Std
6	TP1, TP3, TP5, TP6, TP7, TP8	5000	Test Point, Red, Thru Hole Color Keyed	0.100 x 0.100 inch	5000	Keystone
4	TP2, TP4, TP9, TP10	5001	Test Point, Black, Thru Hole Color Keyed	0.100 x 0.100 inch	5001	Keystone
1	U1	TPS54620RGY	IC, 1.6V-17V Synchronous Buck PWM Converter with Integrated MOSFET	3.5mm x 3.3mm QFN14	TPS54620RGY	TI
2	--		Shunt, 100-mil, Black	0.100	929950-00	3M
1	--		PCB, 2.5" x 2.5" x 0.062"		HPA374	Any

- Notes 1. These assemblies are ESD sensitive, ESD precautions shall be observed.
2. These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
3. These assemblies must comply with workmanship standards IPC-A-610 Class 2.
4. Ref designators marked with an asterisk (***) cannot be substituted. All other components can be substituted with equivalent MFG's components.

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EVM WARNINGS AND RESTRICTIONS

It is important to operate this EVM within the input voltage range and the output current range specified in Table 1.

Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

Applying loads outside of the specified output range may result in unintended operation and/or possible permanent damage to the EVM. Please consult the EVM User's Guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative.

During normal operation, some circuit components may have case temperatures greater than 55°C. The EVM is designed to operate properly with certain components above 60°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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